

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0753310335

Status:

Active

Overview:

gbx_backplane_connector_system

Description:

1.85mm by 1.85mm (.073 by .073") Pitch 3-Pair GbX® Backplane Connector System, Power Module, 6 Circuits, 1.27µm (50µ") Gold (Au), Lead Free

Documents:

Drawing (PDF)

Product Specification PS-75221-999 (PDF)

RoHS Certificate of Compliance (PDF)

General

Product Family

Backplane Connectors

Series

75331

Application

Backplane

Application Tooling Documents

Tooling Manual

Comments

Blade Length A 6.00mm, B 6.00mm, C 7.50mm

Component Type

Power Header

Overview

gbx_backplane_connector_system

Product Name

GbX®

Style

N/A

Physical

Circuits (Loaded)

6

Circuits (maximum)

6

Circuits Detail

Rows A, B & C

Color - Resin

Gray (Dark)

Durability (mating cycles max)

200

First Mate / Last Break

Yes

Guide to Mating Part

No

Keying to Mating Part

None

Material - Metal

High Performance Alloy (HPA)

Material - Plating Mating

Gold

Material - Plating Termination

Tin

Material - Resin

High Temperature Thermoplastic

Number of Columns

N/A

Number of Pairs

3

Number of Rows

3

Orientation

Vertical

PC Tail Length (in)

0.090 In

PC Tail Length (mm)

2.28 mm

PCB Locator

Yes

PCB Retention

Yes

PCB Thickness Recommended (in)

0.063 In

PCB Thickness Recommended (mm)

1.60 mm

Packaging Type

Tube

Pitch - Mating Interface (in)

0.000 In

Pitch - Mating Interface (mm)

0.00 mm

Pitch - Term. Interface (in)

0.102 In

Pitch - Term. Interface (mm)

2.60 mm

Plating min: Mating (µin)

50

Plating min: Mating (µm)

1.25

Plating min: Termination (µin)

30

Plating min: Termination (µm)

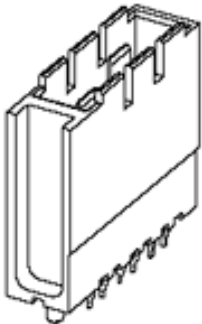
0.75

Polarized to PCB

Yes

Stackable

No



Series
image - Reference only

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Halogen-Free

China RoHS

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
75331Series

Mates With
75292 GbX® Daughtercard

Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shield Type	N/A
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-571
Product Specification	PS-75221-999
Sales Drawing	SD-75331-001

GbX is a registered trademark of Amphenol Corporation.

This document was generated on 05/13/2010

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10 9 8 7 6 5 4 3 2 1



1-UP ASSEMBLY PART NUMBER

7 5 3 3 1 - 0 A B C
- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:
0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:
0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE

NOTES:

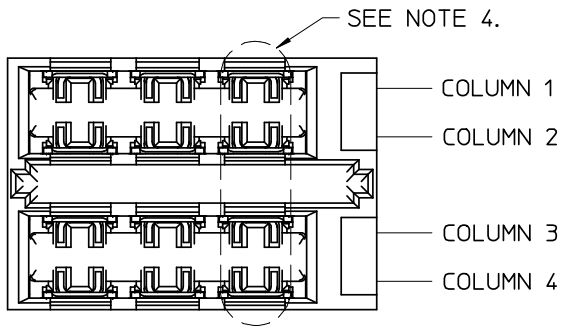
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY.
2. FINISH: SELECT GOLD IN CONTACT AREA, 50 μ " THICK, TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
3. PACKAGING PER PK-70873-571.
4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-3***.
6. PART SHOWN IS 75331-0467.
7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002.



SPEC FILE CORRECTED EC NO: UCP2008-2380 DRAWN:ADVARA 2008/03/27 CHKD:JB INGHAM 2008/03/27 APPR:JB INGHAM 2008/03/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY	DATE	GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED				
			4 PLACES	± ---	± ---	ELO	2005/02/18					
			3 PLACES	± ---	± ---	CHECKED BY	DATE					
			2 PLACES	± ---	± ---	ELO	2005/02/22					
			1 PLACE	± ---	± ---	APPROVED BY	DATE	MOLEX INCORPORATED				
			ANGULAR ± ---°			CUNNINGHAM	2005/02/23					
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
						SEE CHART		SD-75331-001		1 OF 4		
						SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

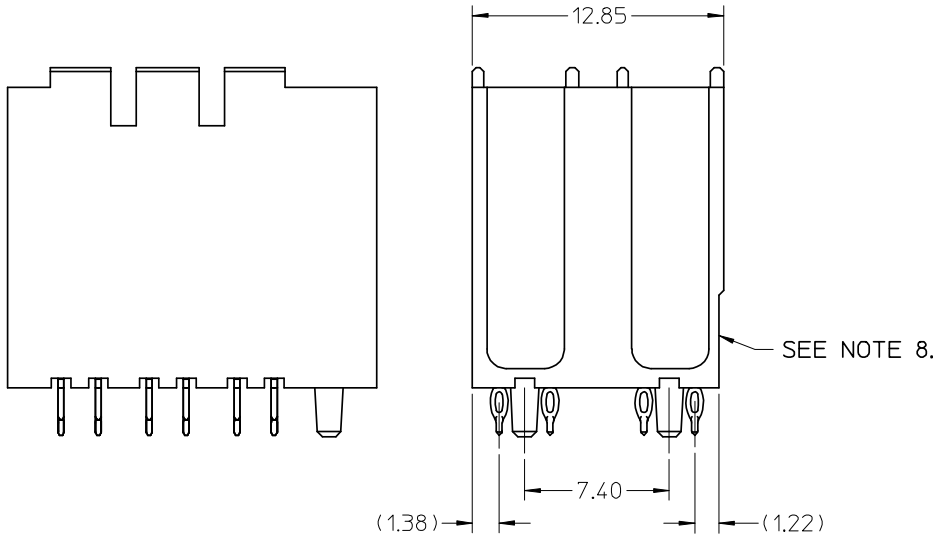
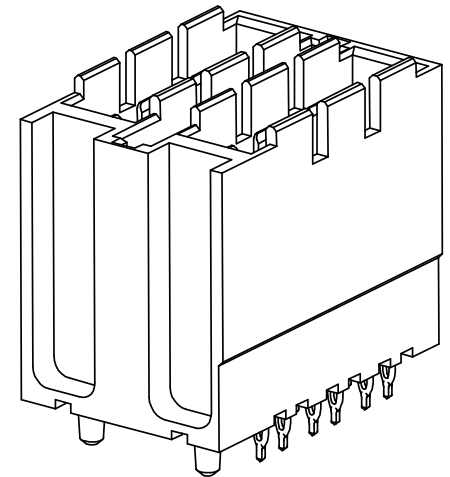
9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

7 5 3 3 2 - 0 A B C
- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:
0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:
0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-2380 DRAWN: J. VARVARA 2008/03/27 CHK'D: J. BINGHAM 2008/03/27 APPR: J. BINGHAM 2008/03/31	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY	DATE	TITLE GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY				
			4 PLACES	± ---	± ---	ELO	2005/02/18					
			3 PLACES	± ---	± ---	CHECKED BY	DATE	MOLEX INCORPORATED				
			2 PLACES	± ---	± ---	ELO	2005/02/22					
			1 PLACE	± ---	± ---	APPROVED BY	DATE	DOCUMENT NO. SD-75331-001				
			ANGULAR ± ---°		CUNNINGHAM	2005/02/23	SHEET NO. 2 OF 4					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO. SEE CHART									
SIZE B THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												

9 8 7 6 5 4 3 2 1



SEE NOTE 4.

3-UP ASSEMBLY PART NUMBER

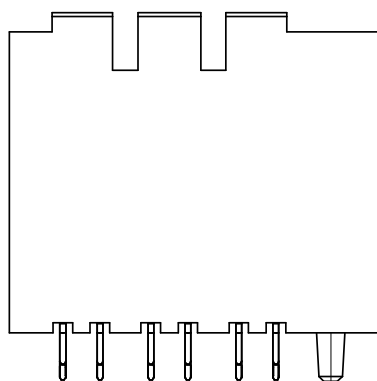
7 5 3 3 3 - 0 A B C

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:

0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C:

0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE

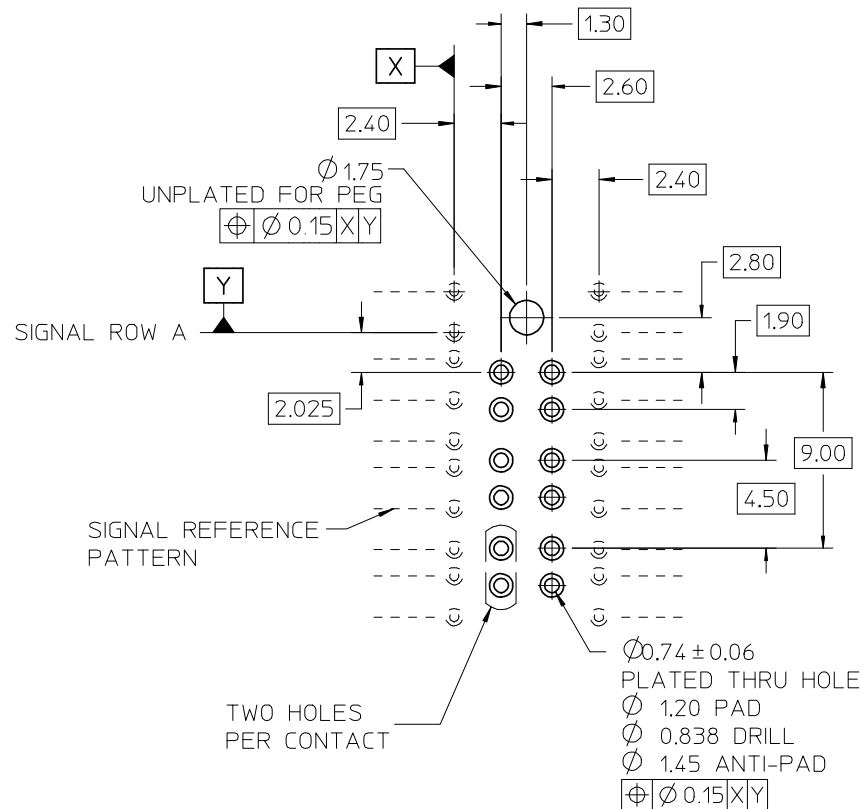
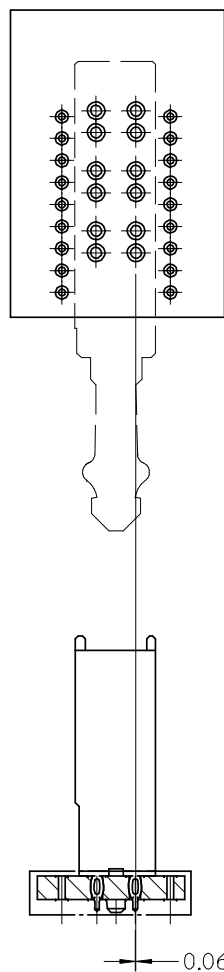
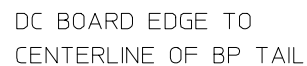


SEE NOTE 8.

14.80

SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-2380 TIDRAWN: D VARIARA 2008/03/27 CHK'D: JB INGHAM 2008/03/27 APPR: JB INGHAM 2008/03/31	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY ELO	DATE 2005/02/18	TITLE GBX 3 PAIR BACKPLANE POWER SALES ASSEMBLY				
			4 PLACES	± ---	± ---	CHECKED BY ELO	DATE 2005/02/22					
			3 PLACES	± ---	± ---	APPROVED BY CUNNINGHAM	DATE 2005/02/23					
			2 PLACES	± ---	± ---	MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
			1 PLACE	± ---	± ---	SEE CHART		SD-75331-001		3 OF 4		
			ANGULAR ± --- °			SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS									



 THIRD ANGLE PROJECTION	
K 3 PAIR PLANE POWER ASSEMBLY	
INCORPORATED	
1-001	SHEET NO. 4 OF 4
IS PROPRIETARY TO MOLEX WITHOUT WRITTEN PERMISSION	

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<http://moschip.ru/get-element>

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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